

# EE566 Solid State Devices

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Dept of Electrical Engineering

University of Notre Dame

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## Assignment 8 SOLUTIONS

### Problem 1: Solution

**PROBLEM II : HBT KIRK-EFFECT (BASE PUSHOUT)**

a)

area =  $(V_{CB} + V_{bi}) = \frac{1}{2\epsilon_s} \left( -qN_{DC} + \frac{J_{Kirk}}{v_{sat}} \right) W_c^2$

$J_{Kirk} = \left[ \frac{2\epsilon_s}{W_c^2} (V_{CB} + V_{bi}) + qN_{DC}^+ \right] v_{sat}$

$$J_{Kirk} = \frac{2\epsilon_s v_{sat} (V_{CB} + V_{bi})}{W_c^2} + qN_{DC}^+ v_{sat}$$

$V_{bi} = \frac{kT}{q} \ln \left( \frac{N_{DC} N_{AB}}{n_i^2} \right) = 1.34 \text{ Volt}$        $v_{sat} (\text{GaAs}) \approx 10^7 \text{ cm/s}$

$\Rightarrow J_{Kirk} = \left[ \frac{2 \times 12.9 \times 8.85 \times 10^{-14} \times 10^{17} \times (4 + 1.34)}{(0.4 + 10^{-7})^2} + 1.6 \times 10^{-19} \times 10^{17} \times 10^7 \right] \text{ A/cm}^2$

$\approx 122 \frac{\text{A}}{\text{cm}^2} + 160 \text{ RA/cm}^2$

$J_{Kirk} \approx 160 \text{ RA/cm}^2$

$J_{Kirk} - qN_{DC}^+ v_{sat} \approx 122 \text{ A/cm}^2$

b)

Area still  $\rightarrow V_{CB} + V_{bi} = \frac{1}{2\epsilon_s} \left[ -qN_{DC}^+ + \frac{J_c}{v_{sat}} \right] W_c'^2$

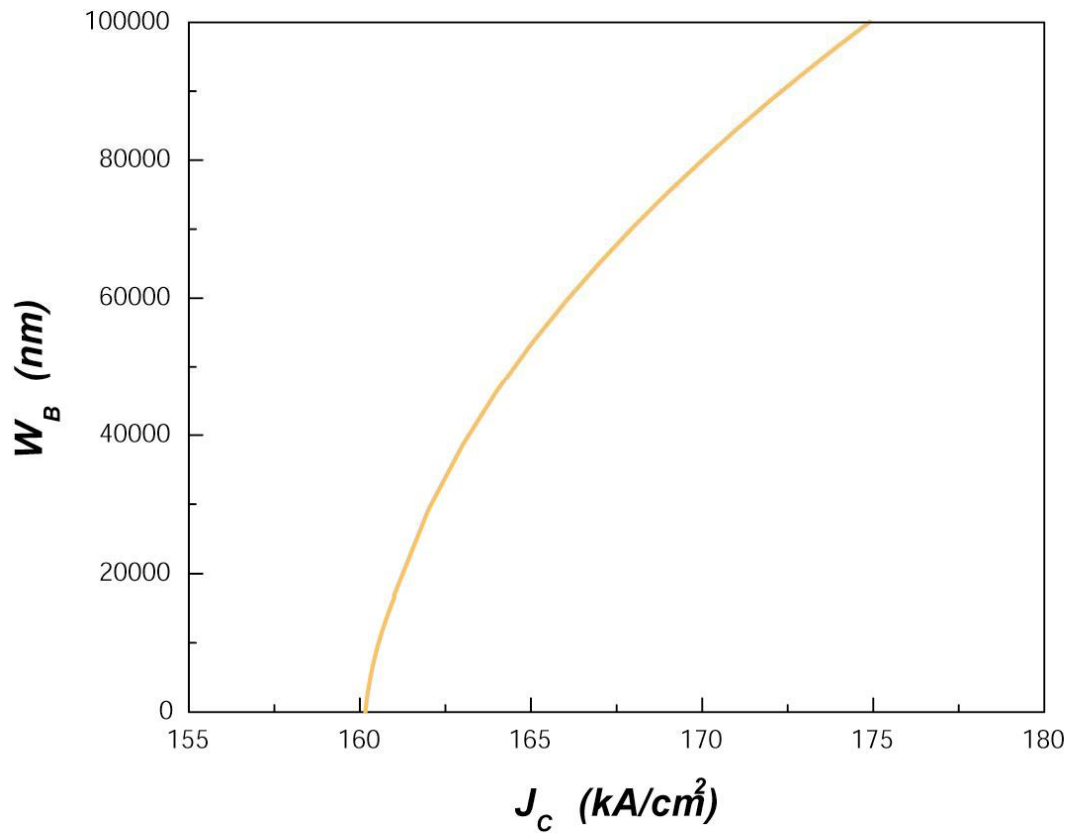
also,  $V_{CB} + V_{bi} = \frac{1}{2\epsilon_s} \left[ -qN_{DC}^+ + \frac{J_{Kirk}}{v_{sat}} \right] W_{c0}^2$

$\therefore \Delta W_B = W_{c0} - W_c'$

$= \left( 1 - \frac{W_c'}{W_{c0}} \right) W_{c0} = W_{c0} \times \left[ 1 - \frac{\sqrt{J_c - qN_{DC}^+ v_{sat}}}{\sqrt{J_{Kirk} - qN_{DC}^+ v_{sat}}} \right]$

$\Delta W_B = W_{c0} \times \left[ 1 - \frac{\sqrt{J_c - qN_{DC}^+ v_{sat}}}{\sqrt{J_{Kirk} - qN_{DC}^+ v_{sat}}} \right]$

Plot on next page.



④

ASSIGNMENT 8 - SOLN<sup>S</sup> CONTD:

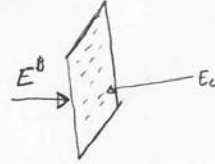
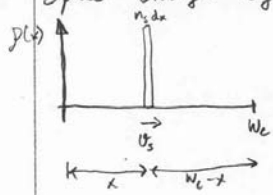
①

Kirk-effect widens the base  $\Rightarrow \Delta N_B \uparrow \Rightarrow \beta_F \downarrow$ .

To reduce the effect,  $w_c \downarrow$ , dope slightly heavily, but not too much since  $\frac{V_{cb}}{V_{bc}}$  Breakdown @ C-B  $j^n$  will suffer!

## Problem 2: Solution

3. The  $e^-$ 's in the depletion are terminated partly on the base and partly on the collector. Why? Consider the following (which is completely analogous to finding the delay through the collector region. In the space charge region.

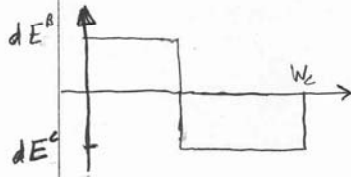


from Gauss' Law we know for a sheet charge the

$$\oint \vec{E} \cdot d\vec{A} = \iint \frac{\sigma}{\epsilon}$$

$$E^B A - E^C A = \frac{\sigma A}{\epsilon}$$

$$E^B - E^C = \frac{\sigma}{\epsilon}$$



$$dE^B - dE^C = \frac{q n_s dx}{\epsilon}$$

$x dE^B + dE^C (W-x) = 0$  Current flowing through the depletion cannot produce a change in Voltage

$$dE^C = -dE^B \left( \frac{x}{W-x} \right)$$

$$dE^B \left( 1 + \frac{x}{W-x} \right) = \frac{q n_s dx}{\epsilon}$$

$$= \frac{J_c dx}{v_{sat} \epsilon}$$

$$dE^B = \frac{dQ_s}{\epsilon} = \frac{J_c dx (W-x)}{v_{sat} \epsilon W}$$

$$Q_s = \frac{J_c}{v_{sat}} \int_0^{W_c} \left( 1 - \frac{x}{W_c} \right) dx$$

$$\tau_{BC} = \frac{Q_s}{J_c} = \frac{1}{v_{sat}} \int_0^{W_c} \left( 1 - \frac{x}{W_c} \right) dx$$

$$= \frac{W_c}{2 v_{sat}}$$

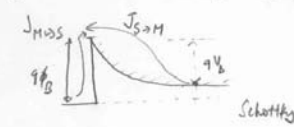
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### Problem 3: Solution

Derivation of Richardson's constant given in various books (Textbook - page 234, and derived using a different flavor in Muller & Kamins – pages 152-155).

PROBLEM I - Solution in textbook, PG 194-203, SHUR.

a) Use Maxwell-Boltzmann-distribution of electron velocities




$J_{S \rightarrow M} - J_{M \rightarrow S} = J = J_0 \left( e^{\frac{qV}{kT}} - 1 \right)$

$\uparrow$

$A^* T^2 e^{-q\phi_B/kT}$


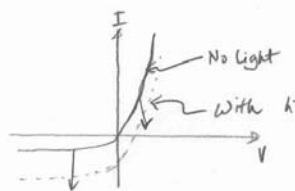
$\uparrow$

$\frac{4\pi q m^* k_B^2}{h^3} \approx 120 \left( \frac{m^*}{m_0} \right) \frac{A}{cm^2 K}$



b) Because thermionic emission current depends only on the barrier-height, which is the same in corresponding Schottky & Mott barriers.

c)

$\Rightarrow$  Acts like a photo detector.

**Problem 4** was open-ended.

Most of the answers are found in the review paper handed out in class –  
“Silicon Device Scaling to the Sub-10-nm Regime”

by Jeong et al,

Science vol 306, page 2057 (2004).

Additional up-to-date information may be found at

<http://public.itrs.net/>

and at

<http://www.intel.com/research/>

Look at the “Silicon” section in the drop-down menu “Technology and Research” at the top of the page – lot of latest information, including the 45nm MOSFET technology.